

Power line chokes

Current-compensated ring core double chokes 250 V AC, 1 ... 82 mH, 0.5 ... 6 A, +40 °C / +45 °C / +50 °C / +60 °C / +70 °C

Series/Type: B82724A/J

Date: February 2025

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Rated voltage 250 V AC Rated current 0.5 ... 6 A / +40 °C, +45 °C, +50 °C, +60 °C, +70 °C Nominal inductance 1 ... 82 mH

B82724A

Construction

- Current-compensated ring core double choke
- Ferrite core wih epoxy coating (UL 94 V-0)
- Plastic case with in-molded pins (UL 94 V-0)¹)
- Potting (UL 94 V-0)
- Sector winding

Features

- High resonance frequency due to special winding technique
- Approx. 1% stray inductance for symmetrical interference suppression
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- UL²⁾ and/or ENEC (VDE) approvals 🔊 🕸
- RoHS-compatible

Applications

- Suppression of common-mode interferences
- Switch-mode power applications
- Electronic ballasts in lamps
- Power inverters

Terminals

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Pins 0.7×0.7 (mm)
- Lead spacing 15 × 12.5 (mm) or 30 × 20 (mm)

Marking

Product brand, approval signs, ordering code, graphic symbol, rated current, rated voltage, nominal inductance date of manufacture, production place identification code

Delivery mode

- Blister tray in cardboard box
- 1) Additionally certified values:

Glow wire flammability index (GWFI to IEC 60695-2-12): +850 °C Glow wire ignition temperature (GWIT to IEC 60695-2-13): +775 °C Comparative tracking index (CTI to IEC 60112): 175 V Ball pressure test (BP to IEC 60695-10-2): +125 °C

2) UL approval with 300 V AC



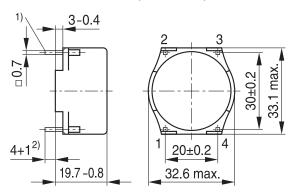


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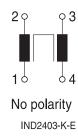
Dimensional drawings and pin configuration

Horizontal version (B82724A)



¹⁾ Tin tips permissible

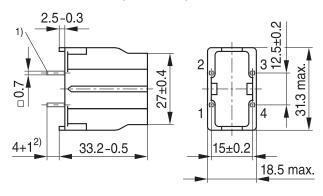
IND2414-7-E



Part tolerances to ISO 2768-c / ISO 8015. Size ISO 14405 (E) All dimensions in mm

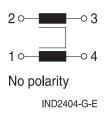
IND2140-B-E

Vertical version (B82724J)



¹⁾ Tin tips permissible

IND2435-Q-E



Part tolerances to ISO 2768-c / ISO 8015. Size ISO 14405 (E)

All dimensions in mm



IND2140-B-E

²⁾ Dimension does not include tin tip

²⁾ Dimension does not include tin tip



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Technical data and measuring conditions

Rated voltage V _R	250 V AC (50/60 Hz)		
Test voltage V _{test}	1500 V AC, 2 s (line/line)		
Rated temperature T _R	+40 °C / +45 °C / +50 °C / +60 °C / +70 °C		
Rated current I _R	Referred to 50 Hz and rated temperature		
Nominal inductance L _N	Measured with Agilent 4284A at 0.1 mA, +20 °C Measuring frequency: $L_R \le 1$ mH = 100 kHz $L_R > 1$ mH= 10 kHz Inductance is specified per winding.		
Inductance tolerance	±30% at +20 °C		
Inductance decrease ΔL/L ₀	< 10% at DC magnetic bias with I _R , +20 °C		
Stray inductance L _{stray,typ}	Measured with Agilent 4284A at 5 mA, +20 °C, typical values $ \begin{array}{l} \text{Measuring frequency: } L_R \leq 1 \text{ mH} = 100 \text{ kHz} \\ L_R > 1 \text{ mH} = 10 \text{ kHz} \\ \end{array} $		
DC resistance R _{typ}	Measured at +20 °C, typical values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 \pm 3) °C, (3 \pm 0.3) s Wetting of soldering area \geq 95% (to IEC 60068-2-20, test Ta)		
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C +40 °C, ≤ 75% RH		
Weight	Approx. 27 g 32 g		
Approvals	IEC/EN 60938-2, UL 1283 (E70122)		
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Characteristics and ordering codes

I _R	L _N	L _{stray,typ}	y,typ R _{typ} T _R Ordering code			Approvals		
Α	mH	μН	mΩ	°C	Horizontal version	Vertical version	<u>ŵ</u>	71
0.5	82.0	1000	2300	+60	B82724A2501N001	B82724J2501N001	×	×
0.5	68.0	700	2000	+70	B82724A2501N020	B82724J2501N020	×	×
8.0	49.0	500	1950	+50	B82724A2801N002	B82724J2801N002	×	×
1.0	39.0	350	750	+60	B82724A2102N021	B82724J2102N021	×	×
1.0	33.0	400	750	+60	B82724A2102N001	B82724J2102N001	×	×
1.4	37.0	320	420	+60	B82724A2142N021	B82724J2142N021	×	×
1.4	27.0	260	460	+50	B82724A2142N001	B82724J2142N001	×	×
1.6	10.0	120	350	+60	B82724A2162N001	B82724J2162N001	×	×
1.8	33.0	300	400	+40	B82724A2182N021	B82724J2182N021	×	×
2.0	6.8	80	170	+60	B82724A2202N001	B82724J2202N001	×	×
2.2	20.0	180	250	+40	B82724A2222N021	B82724J2222N021	×	×
2.2	15.0	140	210	+45	B82724A2222N020	B82724J2222N020	×	×
2.5	10.0	90	140	+40	B82724A2252N020	B82724J2252N020	×	×
2.5	5.6	55	125	+60	B82724A2252N001	B82724J2252N001	×	×
2.7	6.6	60	110	+60	B82724A2272N020	B82724J2272N020	×	×
3.0	12.0	110	125	+40	B82724A2302N021	B82724J2302N021	×	×
3.3	5.6	45	95	+40	B82724A2332N001	B82724J2332N001	×	×
4.0	4.7	40	65	+60	B82724A2402N020	B82724J2402N020	×	×
4.0	3.3	35	65	+60	B82724A2402N001	B82724J2402N001	×	×
4.8	3.3	35	46	+70	B82724A2482N020	B82724J2482N020	×	×
5.0	2.5	25	38	+60	B82724A2502N001	B82724J2502N001	×	×
5.1	4.1	30	46	+60	B82724A2512N020	B82724J2512N020	×	×
6.0	3.3	17	25	+60	B82724A2602N041	B82724J2602N041	×	×
6.0	1.8	20	31	+40	B82724A2602N020	B82724J2602N020	×	×
6.0	1.0	12	23	+60	B82724A2602N001	B82724J2602N001	×	×

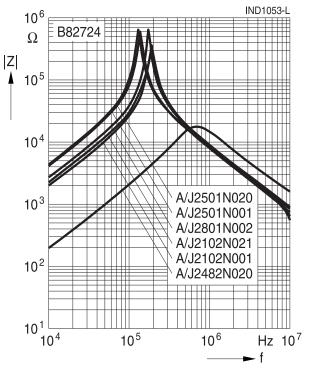
 $[\]times$ = approval granted

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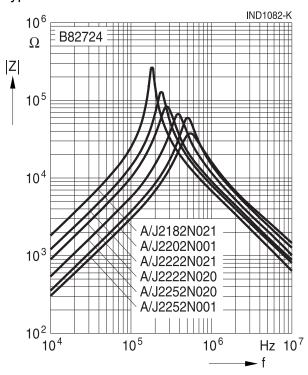
Impedance |Z| versus frequency f

measured with windings in parallel at +20 °C, typical values



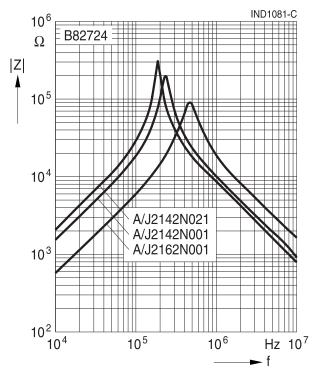
Impedance |Z| versus frequency f

measured with windings in parallel at +20 °C, typical values



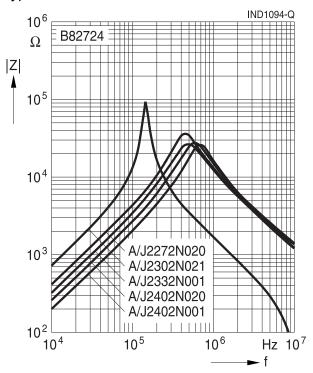
Impedance |Z| versus frequency f

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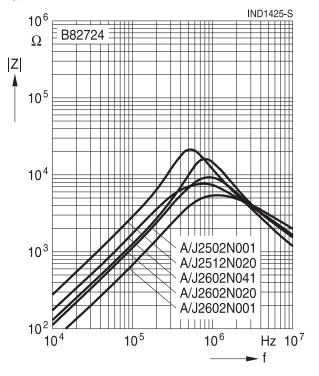


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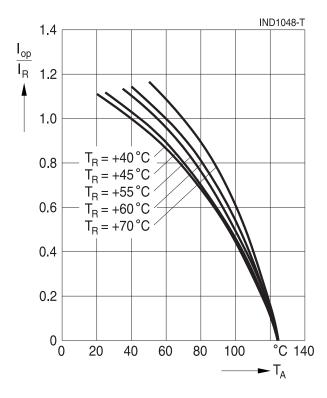
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Impedance |Z| versus frequency f

measured with windings in parallel at +20 °C, typical values



Current derating I_{op}/I_R versus temperature T_A





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a
 pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it
 is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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Cautions and warnings

Display of ordering codes for TDK Electronics products

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- Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.

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Important notes

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